TOSHIBA Bipolar Digital Integrated Circuit Silicon Monolithic

# TD62705PG, TD62705FG, TD62706PG, TD62706FG

#### 6ch High-Voltage Source Driver

The TD62705PG, TD62705FG and TD62706PG, TD62706FG are comprised of six source current transistor array.

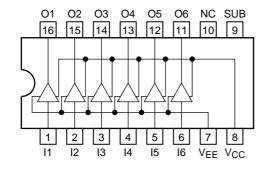
These drivers are specifically designed for fluorescent display applications.

For proper operation, the substrate (SUB) must be connected to the most negative voltage.

#### **Features**

- High output voltage: VCC VOUT = 60 V (min)
- Output current (single output): IOUT = -50 mA (max)
- Input compatible with various types of logic: TD62705PG, TD62705FG R<sub>IN</sub> = 47 k $\Omega$ : 6 to 25 V PMOS, CMOS TD62706PG, TD62706FG R<sub>IN</sub> = 10 k $\Omega$ : TTL, 5 V CMOS
- Package type-PG: DIP-16 pin
- Package type-FG: SOP-16 pin

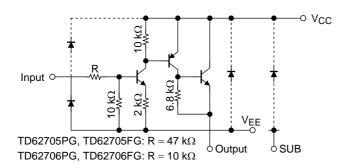
#### Pin Assignment (top view)



# TD62705PG TD62706PG DIP16-P-300-2.54A TD62705FG TD62706FG SOP16-P-225-1.27

Weight
DIP16-P-300-2.54A: 1.11 g (typ.)
SOP16-P-225-1.27: 0.16 g (typ.)

#### Schematics (each driver)



Note: The input and output parasitic diodes cannot be used as clamp diodes.



# **Maximum Ratings (Ta = 25°C)**

| Characteristics       | Symbol                             | Rating                             | Unit                              |       |  |
|-----------------------|------------------------------------|------------------------------------|-----------------------------------|-------|--|
| Supply voltage        | V <sub>CC</sub> – V <sub>EE</sub>  | 30                                 | · V                               |       |  |
| Supply voltage        | V <sub>CC</sub> – V <sub>SUB</sub> | 60                                 |                                   |       |  |
| Output voltage        |                                    | V <sub>CC</sub> – V <sub>OUT</sub> | -60                               | V     |  |
| Input voltage         |                                    | V <sub>IN</sub> – V <sub>EE</sub>  | V <sub>CC</sub> – V <sub>EE</sub> | V     |  |
| Output current        |                                    | lout                               | -50                               | mA/ch |  |
| Input current         |                                    | I <sub>IN</sub>                    | ±10                               | mA    |  |
| Power dissipation     | PG                                 | P <sub>D</sub> (Note 2)            | 1.0                               | W     |  |
| Fower dissipation     | FG                                 | FD (Note 2)                        | 0.625 (Note 1)                    | VV    |  |
| Operating temperature |                                    | T <sub>opr</sub>                   | -40 to 85                         | °C    |  |
| Storage temperature   |                                    | T <sub>stg</sub>                   | -55 to 150                        | °C    |  |

Note 1: On glass epoxy PCB ( $30 \times 30 \times 1.6$  mm Cu 50%)

Note 2: Delated above 25°C in the proportion 8.0 mw/°C (PG type), 5.0 mw/°C (FG type).

## Recommended Operating Conditions ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

| Characteristics   |                        | Symbol           | Test Condition                                | Min              | Тур. | Max   | Unit  |
|-------------------|------------------------|------------------|---|------------------|------|-------|-------|
| Supply voltage    | TD62705PG<br>TD62705FG | V <sub>CC</sub>  | V <sub>EE</sub> = 0 V                         | 6.0              | _    | 25    | . V   |
|                   | TD62706PG<br>TD62706FG |                  |   | 4.5              | _    | 25    |       |
|                   |                        | V <sub>SUB</sub> | V <sub>CC</sub> = 0 V                         | V <sub>OUT</sub> | _    | -55   | V     |
| Output voltage    |                        | V <sub>OUT</sub> | V <sub>CC</sub> = 0 V                         | 0                | _    | -55   | V     |
| Output current    |                        | lout             | _   | 0                | _    | -40   | mA/ch |
| Input voltage     | TD62705PG<br>TD62705FG | V <sub>IN</sub>  | V <sub>EE</sub> = 0 V, V <sub>CC</sub> = 25 V | 0                |      | 25    | - V   |
|                   | TD62706PG<br>TD62706FG |                  |   | 0                | _    | 7     |       |
| Dower dissination | PG                     | P <sub>D</sub>   | _   | _                | —    | 0.36  | W     |
| Power dissipation | FG                     |                  | (Note 3)                                      | _                | _    | 0.325 | VV    |

Note 3: On glass epoxy PCB ( $30 \times 30 \times 1.6$  mm, Cu 50%)



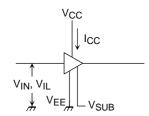
# **Electrical Characteristics (Ta = 25°C)**

| (                          | Characteristi          | cs                     | Symbol                   | Test<br>Circuit  | Test Condition   | Min | Тур. | Max                     | Unit |
|----------------------------|------------------------|------------------------|--------------------------|--|--|-----|------|-------------------------|------|
| Input voltage  Low level   | High level             | TD62705PG<br>TD62705FG | - V <sub>IH</sub>        | 1  | V <sub>EE</sub> = 0 V  | 6.0 | _    | _                       |      |
|                            | riigirievei            | TD62706PG<br>TD62706FG |                          |  | V <sub>EE</sub> = 0 V  | 2.2 | _    | _                       |      |
|                            | Low lovel              | TD62705PG<br>TD62705FG | V <sub>IL</sub> 1        | 1  | V <sub>EE</sub> = 0 V  | _   | _    | 2.2                     |      |
|                            | Low level              | TD62706PG<br>TD62706FG |                          | '  | V <sub>EE</sub> = 0 V  |     | _    | 0.8                     |      |
| Input current High level - | High level             | TD62705PG<br>TD62705FG | · IIH                    | 2  | V <sub>EE</sub> = 0 V, V <sub>IN</sub> = 6.0 V   | l   | 0.11 | 0.16                    | mA   |
|                            | riigirievei            | TD62706PG<br>TD62706FG |                          |  | V <sub>EE</sub> = 0 V, V <sub>IN</sub> = 2.4 V   | l   | 0.12 | 0.18                    |      |
|                            |                        | l <sub>IL</sub>        | 2                        | $V_{EE} = V_{IN} = 0 V,$ $V_{CC} = 25 V$                 | l  | _   | ±1   | μА                      |      |
| Output leaka               | age current            |                        | I <sub>CEX</sub>         | 3  | $V_{EE} = 0 \text{ V}, V_{CC} = 25 \text{ V}, V_{IN} = V_{IL \text{ max}}, I_{OUT} = -30 \text{ V}$  |     | _    | -100                    | μА   |
| Collector-en               | nitter saturati        | on voltage             | V <sub>CE</sub> (sat)    | 4  | $\label{eq:VEE} \begin{aligned} &V_{EE} = 0 \text{ V, V}_{CC} = V_{CC \text{ min}}, \\ &V_{IN} = V_{IH \text{ min}}, \\ &I_{OUT} = -40 \text{ mA} \end{aligned}$ | -   | _    | V <sub>CC</sub><br>-2.5 | ٧    |
| Supply current (output on) | TD62705PG<br>TD62705FG | lee 4                  | 1 VEE = 0 V, VCC = 25 V, | _  | _  | 32  | mA   |                         |      |
|                            |                        | TD62706PG<br>TD62706FG | Icc 1                    | $V_{IN} = V_{IN \text{ max}}$ , $I_{OUT} = 0 \text{ mA}$ | _  | _   | 25   | ША                      |      |
| Turn-on delay              |                        | t <sub>ON</sub>        | 5                        | $R_1 = 1.4 \text{ k}\Omega$ , $C_1 = 15 \text{ pF}$      |  | 0.2 |      | μS                      |      |
| Turn-off delay             |                        | t <sub>OFF</sub>       | 5                        | 11 1.4 1/22, OL - 10 PI                                  | _  | 1.5 | _    | μS                      |      |

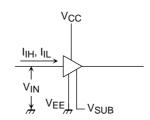
3

#### **Test Circuit**

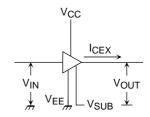
#### 1. VIH, VIL, ICC



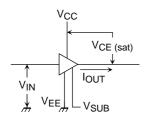
#### 2. I<sub>IH</sub>, I<sub>IL</sub>



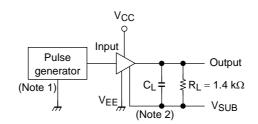
#### 3. ICEX



# 4. V<sub>CE (sat)</sub>



## 5. ton, toff



Note 1: Pulse Width 50 µs, Duty Cycle 50%

Output Impedance 50  $\Omega$ ,  $t_f \le 5$  ns,  $t_f \le 10$  ns

Note 2:  $C_L = 15 pF$  (includes probe and jig capacitance)

### **Input Condition**

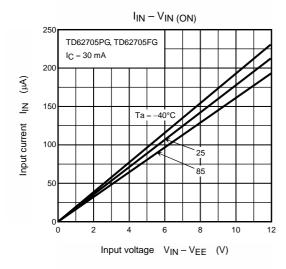
| Type Number          | V <sub>IN</sub> | Vcc  | V <sub>SUB</sub> |  |
|----------------------|-----------------|------|------------------|--|
| TD62705PG, TD62705FG | 0 to 9 V        | 25 V | -30              |  |
| TD62706PG, TD62706FG | 0 to 3 V        | 25 V | -30              |  |

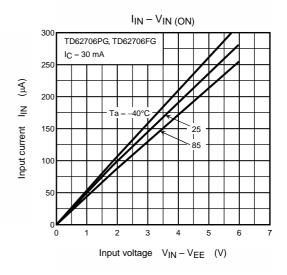
#### **Precautions for Using**

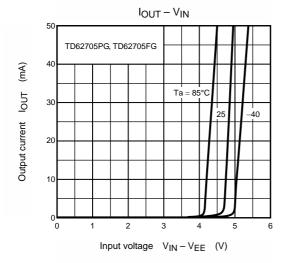
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

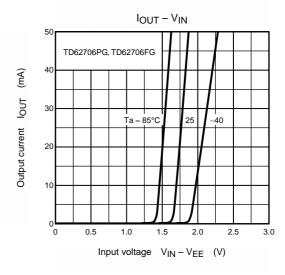
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

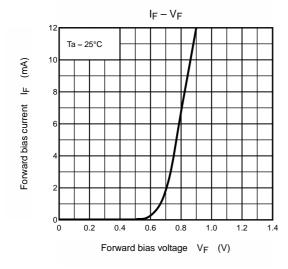
Utmost care is necessary in the design of the output line, V<sub>CC</sub> and GND (SUB, V<sub>EE</sub>) line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

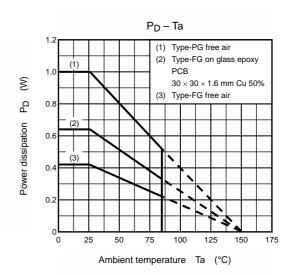






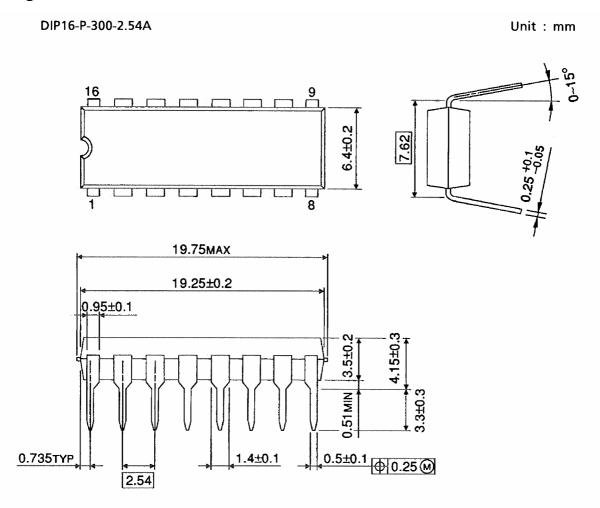






5

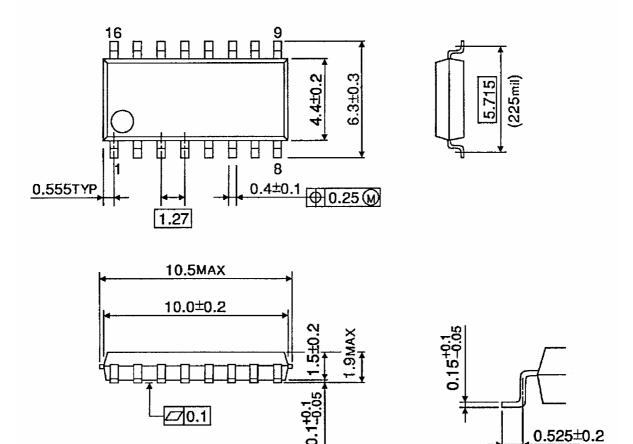
# **Package Dimensions**



Weight: 1.11 g (typ.)

# **Package Dimensions**

SOP16-P-225-1.27 Unit: mm



Weight: 0.16 g (typ.)

About solderability, following conditions were confirmed

Solderability

Use of Sn-63Pb solder Bath

- solder bath temperature = 230°C
- · dipping time = 5 seconds
- · the number of times = once
- · use of R-type flux

Use of Sn-3.0Ag-0.5Cu solder Bath

- · solder bath temperature = 245°C
- · dipping time = 5 seconds
- · the number of times = once
- · use of R-type flux

Handbook" etc..

#### RESTRICTIONS ON PRODUCT USE

030619EBA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.